Onsemi

MOSFET – Power, Single N-Channel, SUPÉRFET[®] V, FRFET[®], TO247-3L 600 V, 55 mΩ, 45 A NVHL055N60S5F

Description

The SUPERFET V MOSFET FRFET series has optimized body diode performance characteristics. This can allow for the removal of components in the application and improve application performance and reliability, particularly when soft switching topologies are used.

Features

- $650 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C} / \text{Typ. } \text{R}_{\text{DS(on)}} = 44 \text{ m}\Omega$
- 100% Avalanche Tested
- Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Electric Vehicle On Board Chargers
- EV Main Battery DC/DC Converters

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

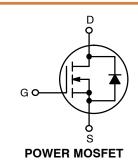
| Parameter | Symbol | Value | Unit | |
|---|--|-----------------------------------|----------------|------|
| Drain-to-Source Voltage | | V _{DSS} | 600 | V |
| Gate-to-Source Voltage | DC | V _{GS} | ±30 | V |
| | AC (f > 1 Hz) | | ±30 | |
| Continuous Drain Current | T _C = 25°C | ۱ _D | 45 | А |
| | T _C = 100°C | | 28 | |
| Power Dissipation | T _C = 25°C | PD | 278 | W |
| Pulsed Drain Current | Τ 0500 | I _{DM} | 159 | А |
| Pulsed Source Current (Body Diode) | T _C = 25°C, t _P = 10 μs | I _{SM} | 159 | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | –55 to +150 | °C |
| Source Current (Body Diode) | | ا _S | 45 | А |
| Single Pulse Avalanche Energy | $(I_L = 7 \text{ A}, R_G = 25 \Omega)$ | E _{AS} | 417 | mJ |
| Avalanche Current | | I _{AS} | 7 | А |
| Repetitive Avalanche Energy (Note 1) | | E _{AR} | 2.78 | mJ |
| MOSFET dv/dt | | dvdt | 120 | V/ns |
| Peak Diode Recovery dv/dt (No | | 70 | | |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | ΤL | 260 | °C |

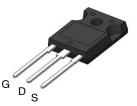
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. $I_{SD} \le 22.5$ A, di/dt ≤ 200 A/µs, $V_{DD} \le 400$ V, starting $T_J = 25^{\circ}$ C.

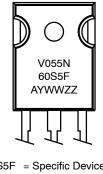
| V _{DSS} | R _{DS(ON)} MAX | I _D MAX |
|------------------|-------------------------|--------------------|
| 600 V | 55 mΩ @ 10 V | 45 A |





TO-247 Long Leads CASE 340CX

MARKING DIAGRAM



V055N60S5F = Specific Device Code = Assembly Location YWW = Data Code (Year & Week) = Assembly Lot

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ΖZ

ORDERING INFORMATION

| Device | Package | Shipping |
|---------------|---------|-----------------|
| NVHL055N60S5F | TO-247 | 30 Units / Tube |

THERMAL RESISTANCE

Reverse Recovery Time

Reverse Recovery Charge

| Parameter | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Thermal Resistance, Junction-to-Case, Max. | $R_{\theta JC}$ | 0.45 | °C/W |
| Thermal Resistance, Junction-to-Ambient, Max. | $R_{\theta JA}$ | 40 | |

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit |
|--|----------------------------------|---|-----|------|------|-------|
| OFF CHARACTERISTICS | • | • | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | V_{GS} = 0 V, I_D = 1 mA, T_J = 25 $^\circ C$ | 600 | - | - | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | $\Delta V_{(BR)DSS}/ \Delta T_J$ | I_D = 10 mA, Referenced to 25°C | _ | 581 | - | mV/°C |
| Zero Gate Voltage Drain Current | I _{DSS} | V_{GS} = 0 V, V_{DS} = 600 V, T_{J} = 25°C | _ | - | 10 | μΑ |
| Gate-to-Source Leakage Current | I _{GSS} | $V_{GS}=\pm30~V,~V_{DS}=0~V$ | Ι | - | ±100 | nA |
| ON CHARACTERISTICS | | | | | | |
| Drain-to-Source On Resistance | R _{DS(on)} | V_{GS} = 10 V, I_D = 22.5 A, T_J = 25 $^\circ C$ | _ | 44 | 55 | mΩ |
| Gate Threshold Voltage | V _{GS(th)} | V_{GS} = V_{DS} , I_D = 5.2 mA, T_J = 25°C | 3.2 | - | 4.8 | V |
| Forward Trans-conductance | 9FS | $V_{DS} = 20 \text{ V}, \text{ I}_{D} = 22.5 \text{ A}$ | - | 44.8 | - | S |
| CHARGES, CAPACITANCES & GATE | RESISTANCE | | | | | |
| Input Capacitance | C _{ISS} | V_{DS} = 400 V, V_{GS} = 0 V, f = 250 kHz | _ | 4603 | - | pF |
| Output Capacitance | C _{OSS} | | - | 72.9 | - | |
| Time Related Output Capacitance | C _{OSS(tr.)} | $I_{D} = Constant, V_{DS} = 0 V to 400 V, \\ V_{GS} = 0 V$ | _ | 1114 | - | |
| Energy Related Output Capacitance | C _{OSS(er.)} | V_{DS} = 0 V to 400 V, V_{GS} = 0 V | - | 125 | - | |
| Total Gate Charge | Q _{G(tot)} | V_{DD} = 400 V, I _D = 22.5 A, V _{GS} = 10 V | - | 85.2 | - | nC |
| Gate-to-Source Charge | Q _{GS} | | - | 26.2 | - | |
| Gate-to-Drain Charge | Q _{GD} | | - | 24.9 | - | |
| Gate Resistance | R _G | f = 1 MHz | - | 4.32 | - | Ω |
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-On Delay Time | t _{d(on)} | $V_{GS} = 0/10 \text{ V}, V_{DD} = 400 \text{ V},$ | _ | 44 | - | ns |
| Rise Time | t _r | I_D = 22.5 A, R_G = 4.7 Ω | - | 26.2 | - |] |
| Turn-Off Delay Time | t _{d(off)} |] | _ | 108 | - | 1 |
| Fall Time | t _f | 1 | - | 2.6 | - | 1 |
| SOURCE-TO-DRAIN DIODE CHARAC | TERISTICS | • | | - | - | |
| Forward Diode Voltage | V _{SD} | V_{GS} = 0 V, I_{SD} = 22.5 A, T_J = 25 $^\circ C$ | - | - | 1.2 | V |
| | | | | 1 | 1 | 1 |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

t_{RR}

 $\mathsf{Q}_{\mathsf{R}\mathsf{R}}$

 $\begin{array}{l} V_{GS} = 0 \ V, \ I_{SD} = 22.5 \ A, \\ dI/dt = 100 \ A/\mu s, \ V_{DD} = 400 \ V \end{array}$

128

758

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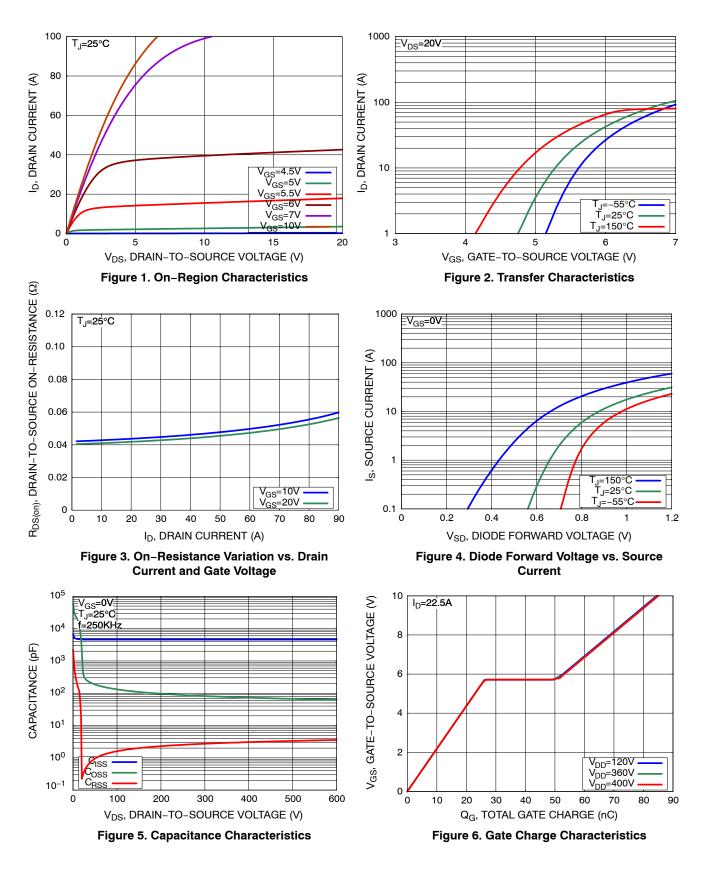
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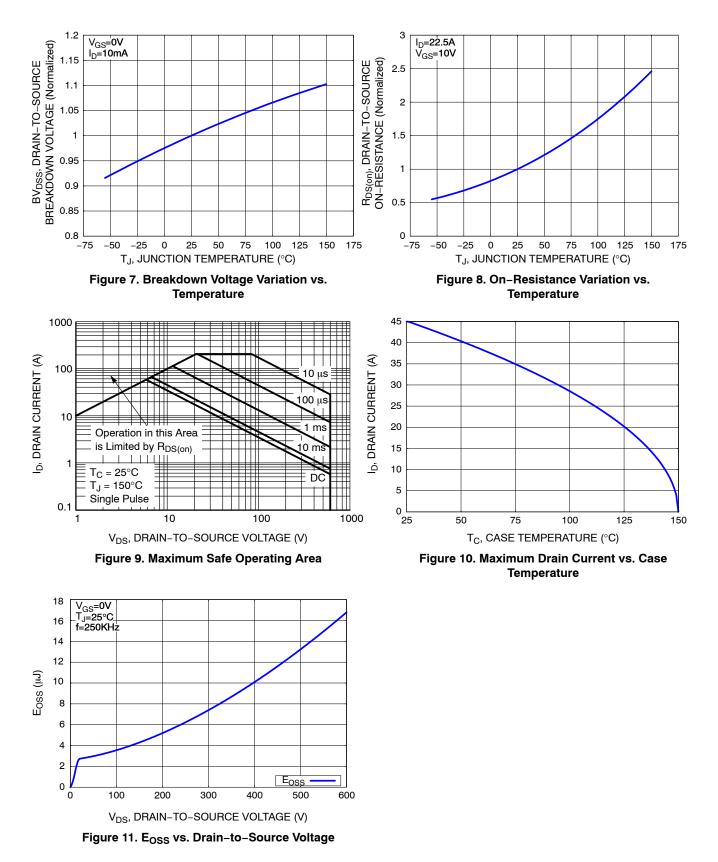
ns

nC

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

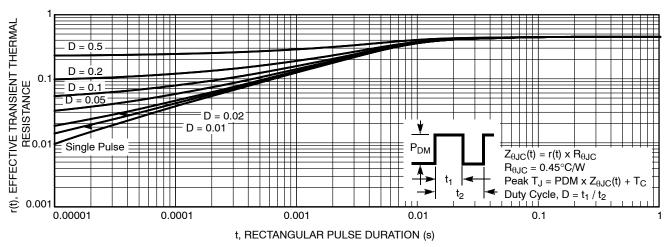


Figure 12. Transient Thermal Impedance

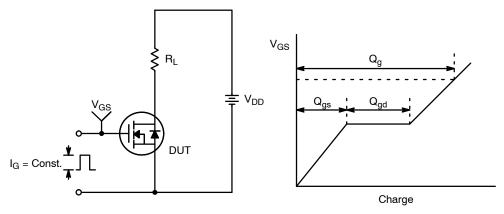


Figure 13. Gate Charge Test Circuit & Waveform

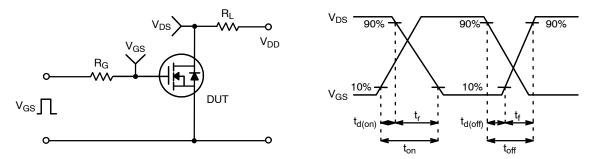


Figure 14. Resistive Switching Test Circuit & Waveforms

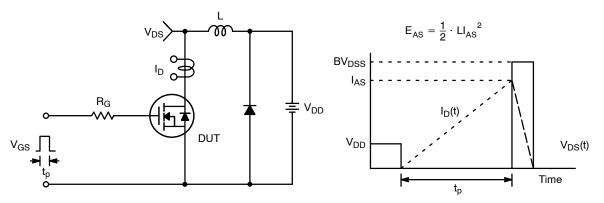


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

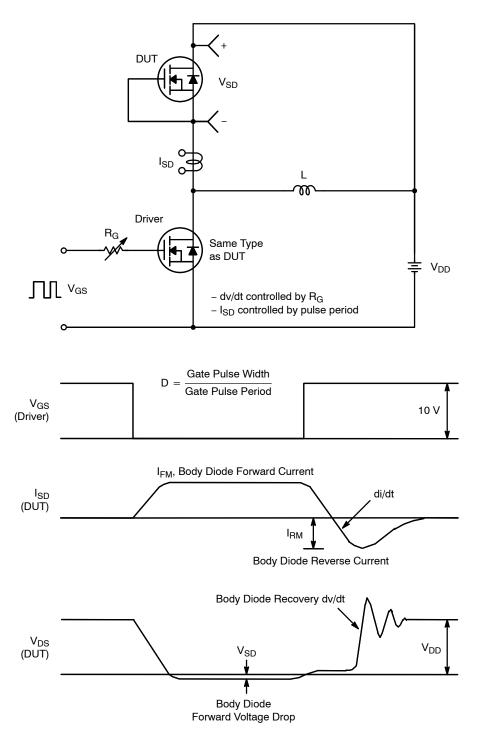
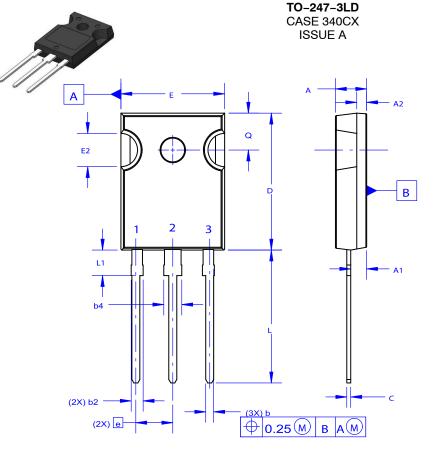


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

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GENERIC **MARKING DIAGRAM*** Х



| XXXXX | = Specific Device Code |
|-------|------------------------|
| Α | = Assembly Location |

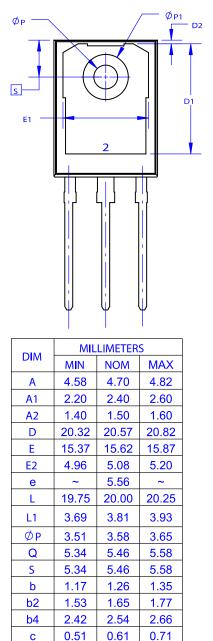
- = Assembly Location
- = Year
- ww = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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DATE 06 JUL 2020



D1

D2

E1

ØP1

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12.81

6.60

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0.93

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7.00

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